


IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/656,848 Confirmation No.: 8582
Applicant : Ka-Ngo Leung, et al.
Title : NEGATIVE ION SOURCE WITH EXTERNAL RF ANTENNA
Filed : 09/06/2003
TC/A.U. : 1763
Examiner : Dhingra, Rakesh Kumar
Docket No. : IB-1826A
Cust. No. : 08076

CERTIFICATE OF MAILING OR FACSIMILE TRANSMISSION

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Name (Type/Print) Hadiyah Muhammad

Signature 

Date 11/10/2005

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22213-1450

AMENDMENT/RESPONSE

Dear Sir:

In response to the Office Action mailed 08/10/2005, please amend the above-identified U.S. patent application as follows:

Amendments to the Specification are found on page 2 of this paper.

A Listing Of Claims begins on page 6 of this paper.

Amendments to the Abstract are found on page 9 and includes a replacement abstract.

Remarks/Arguments begin on page 10 of this paper.

Amendments to the Specification

Please replace the paragraph beginning on page 4, lines 5-15, with the following amended paragraph:

The invention is a radio frequency (RF) driven plasma ion source with an external RF antenna, i.e. the RF antenna is positioned outside the plasma generating chamber rather than inside. The RF antenna is typically formed of a small diameter metal tube coated with an insulator. ~~A flange is~~ Two flanges are used to mount the external RF antenna assembly to the ion source. The RF antenna tubing is wound around ~~the flange~~ an open inner cylinder to form a coil. The external RF antenna assembly ~~flange~~ is formed of a material, e.g. quartz, ~~that which~~ is essentially transparent to the RF waves. The external RF antenna assembly ~~flange~~ is attached to and forms a part of the plasma source chamber so that the RF waves emitted by the RF antenna enter into the inside of the plasma chamber and ionize a gas contained therein. The plasma ion source is typically a multi-cusp ion source. A particular embodiment of the ion source with external antenna includes a sputtering converter for production of negative ions. A LaB₆ converter can be used for boron ions.

Please replace the paragraph beginning on page 4, lines 20-21, with the following amended paragraph:

Figures 6A, B are end and side views of ~~a flange~~ an external RF antenna assembly for mounting an external RF antenna to a plasma ion source according to the invention.

Please replace the paragraphs beginning on page 5, lines 17-22 through page 6, lines 1-17, with the following amended paragraphs:

A plasma ion source 10, which incorporates an external RF antenna 12, is illustrated in Figure 1. Plasma ion source 10 is preferably a multi-cusp ion source having a plurality of permanent magnets 14 arranged with alternating polarity around a source chamber 16, which is typically cylindrical in shape. External antenna 12 is wound around external RF antenna assembly flange-18 and electrically connected to a RF power source 20 (which includes suitable matching circuits), typically 2MHz or 13.5 MHz. ~~Flange-~~The external RF antenna assembly 18 is made of a material such as quartz that easily transmits the RF waves. ~~Flange-~~The external RF antenna assembly 18 is mounted between two plasma chamber body sections 22a, 22b, typically with O-rings 24 providing a seal. Chamber body sections 22a, 22b are typically made of metal or other material that does not transmit RF waves therethrough. The chamber body sections 22a, 22b and the external RF antenna assembly flange-18 together define the plasma chamber 16 therein. Gas inlet 26 in (or near) one end of chamber 16 allows the gas to be ionized to be input into source chamber 16.

The opposed end of the ion source chamber 16 is closed by an extractor 28 which contains a central aperture 30 through which the ion beam can pass or be extracted by applying suitable voltages from an associated extraction power supply 32. Extractor 28 is shown as a simple single electrode but may be a more complex system, e.g. formed of a plasma electrode and an extraction electrode, as is known in the art. Extractor 28 is also shown with a single extraction aperture 30 but may contain a plurality of apertures for multiple beamlet extraction.

In operation, the RF driven plasma ion source 10 produces ions in source chamber 16 by inductively coupling RF power from external RF antenna 12 through ~~flange-~~the external RF

antenna assembly 18 into the gas in chamber 16. The ions are extracted along beam axis 34 through extractor 28. The ions can be positive or negative; electrons can also be extracted.

Please replace the paragraphs beginning on page 6, lines 21-23 through page 7, lines 1-10, with the following amended paragraphs:

Plasma ion source 40, shown in Figure 2, is similar to plasma ion source 10 of Figure 1, except that ~~flange the external RF antenna assembly 18~~ with external antenna 12 is mounted to one end of a single plasma chamber body section 22 instead of between two body sections 22a, 22b. The chamber body section 22 and the external RF antenna assembly flange-18 together define the plasma chamber 16 therein. The extractor 28 is mounted directly to the external RF antenna assembly flange 18 in place of the second body section so that external RF antenna assembly flange 18 is mounted between body section 22 and extractor 30.

Plasma ion source 42, shown in Figure 3, is similar to plasma ion source 40 of Figure 2, with ~~flange the external RF antenna assembly 18~~ with external antenna 12 mounted to the end of a single plasma chamber body section 22. However, ion source 42 is much more compact than ion source 40 since the chamber body section 22 is much shorter, i.e. chamber 16 is much shorter. In Figure 2, the length of chamber body section 22 is much longer than the length of ~~flange the external RF antenna assembly 12~~ while in Figure 3 it is much shorter. Such a short ion source is not easy to achieve with an internal antenna.

Please replace the paragraph beginning on page 7, lines 16-22 through page 8, lines 1-9, with the following amended paragraph:

Plasma ion source 50, shown in Figure 5, is similar to plasma ion source 42 of Figure 3, but is designed for negative ion production. An external antenna arrangement is ideal for surface

conversion negative ion production. A negative ion converter 52 is placed in the chamber 16.

Antenna 12 is located between the converter 52 and aperture 30 of extractor 28. ~~A dense~~ Dense plasma can be produced in front of the converter surface. The thickness of the plasma layer can be optimized to reduce the negative ion loss due to stripping.

Figures 6A, B illustrate the structure of a ~~flange~~ an external RF antenna assembly 18 of Figures 1-5 for housing and mounting an external antenna to a plasma ion source. ~~Flange~~ The external RF antenna assembly 18 is formed of an open inner cylinder 60 having a ~~a~~ an inner diameter D1 and a pair of annular ~~end-pieces~~ flanges 62 attached to the ends of cylinder ~~62-60~~ and extending outward (from inner diameter D1) to a greater outer diameter D2. Spaced around the outer perimeter of the annular flanges ~~pieces-62~~ are a plurality of support pins 64 extending between the flanges ~~pieces-62~~ to help maintain structural integrity. The inner cylinder 60 and extending ~~end~~ flanges ~~pieces-62~~ define a channel 66 in which an RF antenna coil can be wound. The channel 66 has a length T1 and the flange has a total length T2.

Listing Of Claims

The following is a listing of claims:

1. (Original) A plasma ion source for producing negative ions, comprising:
 - a source chamber;
 - an RF antenna mounted external to the chamber;
 - an RF power source coupled to the RF antenna for generating a plasma containing positive ions in a gas in the source chamber;
 - a converter mounted in the source chamber and negatively biased with respect to the source chamber and plasma to produce the negative ions by sputtering surface ionization of the converter by the positive ions.
2. (Original) The plasma ion source of Claim 1 wherein the source chamber comprises a quartz tube mounted between a pair of end plates.
3. (Original) The plasma ion source of Claim 1 wherein the converter is made of LaB_6 to produce boron ions.
4. (Original) The plasma ion source of Claim 3 wherein the plasma generated in the source chamber is an argon ion plasma.
5. (Original) The plasma ion source of Claim 1 further comprising a cylindrical sputtering shield mounted in the source chamber.

6. (Original) The plasma ion source of Claim 5 wherein the cylindrical sputtering shield contains a plurality of spaced slots, one of the slots extending the length of the shield.

7. (Original) The plasma ion source of Claim 1 wherein the RF antenna is formed of a coil of copper or other conducting tubing.

8. (Original) The plasma ion source of Claim 1 wherein the source chamber further comprises:

an extraction aperture;

a pair of spaced extraction electrodes mounted at the aperture.

9. (Original) The plasma ion source of Claim 8 further comprising a magnetic filter mounted at the extraction aperture to reduce extracted electron current.

10. (Original) The plasma ion source of Claim 9 further comprising a pair of spaced electron separator magnets positioned after the extraction electrodes to deflect electrons.

11. (Original) The plasma ion source of Claim 8 wherein the converter surface has a spherical curvature with a radius equal to the length of the source chamber for focusing the negative ions on the extraction aperture.

12. (Original) The plasma ion source of Claim 1 wherein the plasma ion source operates at about 300-800 W RF power, 8-10 mTorr gas pressure, and 0.5-1 kV converter bias.

Amendments to the Abstract

Please replace the Abstract with the following amended Abstract:

A radio frequency (RF) driven plasma ion source has an external RF antenna, i.e. the RF antenna is positioned outside the plasma generating chamber rather than inside. The RF antenna is typically formed of a small diameter metal tube coated with an insulator. ~~A flange~~ An external RF antenna assembly is used to mount the external RF antenna to the ion source. The RF antenna tubing is wound around the external RF antenna assembly flange to form a coil. The external RF antenna assembly flange is formed of a material, e.g. quartz, ~~that which~~ is essentially transparent to the RF waves. The external RF antenna assembly flange is attached to and forms a part of the plasma source chamber so that the RF waves emitted by the RF antenna enter into the inside of the plasma chamber and ionize a gas contained therein. The plasma ion source is typically a multi-cusp ion source. A converter can be included in the ion source to produce negative ions.

Enclosed:

Replacement Abstract

REMARKS/ARGUMENTS

This is in response to the office action dated 8/10/05. Reconsideration is hereby requested in view of the remarks below. Claims 1-12 are currently pending.

Amendments have been made to the specification to further clarify the invention. No new matter has been added.

Informal Objections

The specification has been objected to because on "Page 8, line 4: it is suggested to change "62" to "60"." This objection is respectfully traversed. The specification has been amended as requested by the Examiner. No new matter has been added. It is respectfully requested that this objection be withdrawn.

First Claim Rejection under 35 USC §103

Claims 1, 4, 8, and 11 stand rejected under USC 103(a) as being allegedly unpatentable over Leung et al (USP 6,768,120) in view of Whealton et al (USP 4,602,161). This rejection is respectfully traversed.

According to MPEP §2136.02, for "applications filed on or after November 29, 1999, if the applicant provides evidence that the application and prior art reference were owned by the same person, or subject to an obligation of assignment to, the same person, at the time the invention was made, any rejections under 35 U.S.C. ...103 based upon such a commonly owned reference should not be made or maintained."

The present application and Patent No. 6,768,120 were, at the time the invention of the present application was made, owned by The Regents of the University of California. The assignment for Patent No. 6,768,120 can be found in reel/frame number

013595/0295 and the assignment for the present application can be found in reel/frame number 014941/0867.

Accordingly it is respectfully requested that this rejection be withdrawn.

Second Claim Rejection under 35 USC §103

Claims 1, 4, and 8 stand rejected under USC 103(a) as being allegedly upatentable over Leung et al (USP 6,768,120) in view of admitted prior art. This rejection is respectfully traversed.

The present application and Patent No. 6,768,120 were, at the time the invention of the present application was made, owned by The Regents of the University of California. The assignment for Patent No. 6,768,120 can be found in reel/frame number 013595/0295 and the assignment for the present application can be found in reel/frame number 014941/0867.

Accordingly it is respectfully requested that this rejection be withdrawn.

Dependent Claims


As to the dependent claims, the same arguments would apply. The base claim being allowable, the dependent claims must also be allowable. Accordingly it is respectfully requested that these rejections be withdrawn.

Conclusion

It is believed that this Amendment places the above-identified patent application into condition for allowance. Therefore, applicant respectfully requests that a notice of allowance be issued. If, in the opinion of the Examiner, an interview would expedite the prosecution of this application, the Examiner is invited to call the undersigned attorney at the number indicated below.

Date: November 10, 2005

Respectfully submitted,

A handwritten signature in black ink, appearing to read 'Adrienne Yeung', with a stylized flourish at the end.

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